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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	H8SX
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	EBI/EMI, I²C, IrDA, SCI, SmartCard, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	92
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	56K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 8x10b; D/A 2x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LFQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f61668rd50fpv

Table 1.2 Comparison of Support Functions in the H8SX/1668R Group and H8SX/1668M Group

Function		H8SX/1668R Group	H8SX/1668M Group
DMAC		O	O
DTC		O	O
PPG		O	O
UBC		O	O
SCI		O	O
IIC2		O	O
TMR		O	O
WDT		O	O
10-bit ADC		O	O
8-bit DAC		O	O
EXDMAC		O	O
SDRAM interface		O	O
32K timer		O	O
POR/LVD		—	O
Package	LQFP-144	O	O
	LFBGA-176	O	O

2.7.1 Instructions and Addressing Modes

Table 2.2 indicates the combinations of instructions and addressing modes that the H8SX CPU can use.

Table 2.2 Combinations of Instructions and Addressing Modes (1)

			Addressing Mode								
Classification	**Instruction**	**Size**	**#xx**	**Rn**	**@ERn**	**@(d,ERn)**	**@(d, RnL.B/ Rn.W/ ERn.L)**	**@–ERn/ @ERn+/ @ERn–/ @+ERn**	**@aa:8**	**@aa:16/ @aa:32**	**—**
Data transfer	MOV	B/W/L	S	SD	SD	SD	SD	SD		SD	
		B		S/D					S/D		
	MOVFPE, MOVTPE	B		S/D						S/D*[1]	
	POP, PUSH	W/L		S/D				S/D*[2]			
	LDM, STM	L		S/D				S/D*[2]			
	MOVA*[4]	B/W		S	S	S	S	S		S	
Block transfer	EEPMOV	B									SD*[3]
	MOVMD	B/W/L									SD*[3]
	MOVSD	B									SD*[3]
Arithmetic operations	ADD, CMP	B	S	D	D	D	D	D	D	D	
		B		S	D	D	D	D	D	D	
		B		D	S	S	S	S	S	S	
		B			SD	SD	SD	SD		SD	
		W/L	S	SD	SD	SD	SD	SD		SD	
	SUB	B	S		D	D	D	D	D	D	
		B		S	D	D	D	D	D	D	
		B		D	S	S	S	S	S	S	
		B			SD	SD	SD	SD		SD	
		W/L	S	SD	SD	SD	SD	SD		SD	
	ADDX, SUBX	B/W/L	S	SD							
		B/W/L	S		SD						
		B/W/L	S					SD*[5]			
	INC, DEC	B/W/L		D							
	ADDS, SUBS	L		D							
	DAA, DAS	B		D							
	MULXU, DIVXU	B/W	S:4	SD							
	MULU, DIVU	W/L	S:4	SD							

Classification	Instruction	Size	Addressing Mode								
			#xx	Rn	@ERn	@(d,ERn)	@(d, RnL.B/ Rn.W/ ERn.L)	@–ERn/ @ERn+/ @ERn–/ @+ERn	@aa:8	@aa:16/ @aa:32	—
Bit manipulation	BFLD	B		D	S				S	S	
	BFST	B		S	D				D	D	
Branch	BRA/BS, BRA/BC*[8]	B			S				S	S	
	BSR/BS, BSR/BC*[8]	B			S				S	S	
System control	LDC (CCR, EXR)	B/W*[9]	S	S	S	S		S*[10]		S	
	LDC (VBR, SBR)	L		S							
	STC (CCR, EXR)	B/W*[9]		D	D	D		D*[11]		D	
	STC (VBR, SBR)	L		D							
	ANDC, ORC, XORC	B	S								
	SLEEP	—									O
	NOP	—									O

[Legend]

d: d:16 or d:32

S: Can be specified as a source operand.

D: Can be specified as a destination operand.

SD: Can be specified as either a source or destination operand or both.

S/D: Can be specified as either a source or destination operand.

S:4: 4-bit immediate data can be specified as a source operand.

Notes:
1. Only @aa:16 is available.
2. @ERn+ as a source operand and @–ERn as a destination operand
3. Specified by ER5 as a source address and ER6 as a destination address for data transfer.
4. Size of data to be added with a displacement
5. Only @ERn– is available
6. When the number of bits to be shifted is 1, 2, 4, 8, or 16
7. When the number of bits to be shifted is specified by 5-bit immediate data or a general register
8. Size of data to specify a branch condition
9. Byte when immediate or register direct, otherwise, word
10. Only @ERn+ is available
11. Only @–ERn is available
12. Only when the multiplier is available.

4.3 Register Descriptions

This LSI has the following registers for resets.

- Reset status register (RSTSR)
- Reset control/status register (RSTCSR)

4.3.1 Reset Status Register (RSTSR)

RSTSR indicates a source for generating an internal reset and voltage monitoring interrupt.

Bit	7	6	5	4	3	2	1	0
Bit name	DPSRSTF	—	—	—	—	LVDF*2	—	PORF*2
Initial value:	0	0	0	0	0	0*3	0*3	0*3
R/W:	R/(W)*1	R/W	R/W	R/W	R/W	R/W*4	R/W	R/W*5

Notes: 1. Only 0 can be written to clear the flag.
2. Supported only by the H8SX/1668M Group.
3. Initial value is undefined in the H8SX/1668M Group.
4. Only 0 can be written to clear the flag in the H8SX/1668M Group.
5. Only read is possible in the H8SX/1668M Group.

Bit	Bit Name	Initial Value	R/W	Description
7	DPSRSTF	0	R/(W)*1	Deep Software Standby Reset Flag Indicates that deep software standby mode is canceled by an interrupt source specified with DPSIER or DPSIEGR and an internal reset is generated. [Setting condition] When deep software standby mode is canceled by an interrupt source. [Clearing conditions] • When this bit is read as 1 and then written by 0. • When a pin reset, power-on reset*2 or voltage-monitoring reset*2 is generated.
6 to 3	—	All 0	R/W	Reserved These bits are always read as 0. The write value should always be 0.

When an address error occurs, the following is performed to halt the DTC, DMAC, and EXDMAC.

- The ERR bit of DTCCR in the DTC is set to 1.
- The ERRF bit of DMDR_0 in the DMAC is set to 1.
- The ERRF bit of EDMDR_0 in the EXDMAC is set to 1.
- The DTE bits of DMDRs for all channels in the DMAC are cleared to 0 to forcibly terminate transfer.
- The DTE bits of EDMDRs for all channels in the EXDMAC are cleared to 0 to forcibly terminate transfer.

Table 6.6 shows the state of CCR and EXR after execution of the address error exception handling.

Table 6.6 Status of CCR and EXR after Address Error Exception Handling

	CCR		EXR	
Interrupt Control Mode	**I**	**UI**	**T**	**I2 to I0**
0	1	—	—	—
2	1	—	0	7

[Legend]

1: Set to 1

0: Cleared to 0

—: Retains the previous value.

9.2.3 Wait Control Registers A and B (WTCRA, WTCRB)

WTCRA and WTCRB select the number of program wait cycles for each area in the external address space.

• WTCRA

Bit	15	14	13	12	11	10	9	8
Bit Name	—	W72	W71	W70	—	W62	W61	W60
Initial Value	0	1	1	1	0	1	1	1
R/W	R	R/W	R/W	R/W	R	R/W	R/W	R/W

Bit	7	6	5	4	3	2	1	0
Bit Name	—	W52	W51	W50	—	W42	W41	W40
Initial Value	0	1	1	1	0	1	1	1
R/W	R	R/W	R/W	R/W	R	R/W	R/W	R/W

• WTCRB

Bit	15	14	13	12	11	10	9	8
Bit Name	—	W32	W31	W30	—	W22	W21	W20
Initial Value	0	1	1	1	0	1	1	1
R/W	R	R/W	R/W	R/W	R	R/W	R/W	R/W

Bit	7	6	5	4	3	2	1	0
Bit Name	—	W12	W11	W10	—	W02	W01	W00
Initial Value	0	1	1	1	0	1	1	1
R/W	R	R/W	R/W	R/W	R	R/W	R/W	R/W

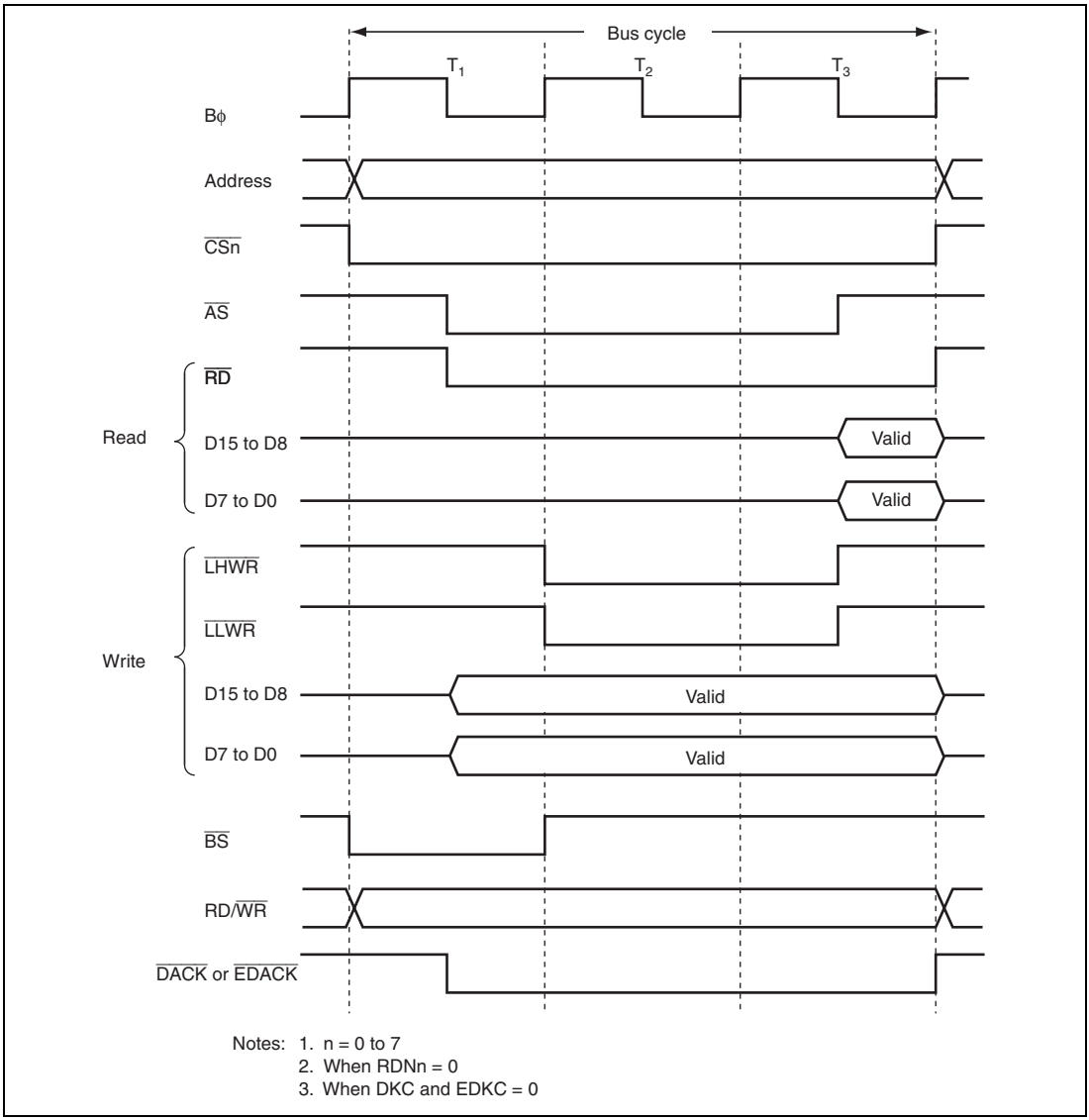

Figure 9.20 16-Bit 3-State Access Space Bus Timing (Word Access for Even Address)

9.8.4 Basic Timing

The number of access cycles in the initial cycle (full access) on the burst ROM interface is determined by the basic bus interface settings in ABWCR, ASTCR, WTCRA, WTCRB, and bits CSXHn in CSACR (n = 0 to 7). When area 0 or area 1 designated as burst ROM space is read by the CPU or EXDMAC cluster transfer, the settings in RDNCR and bits CSXTn in CSACR (n = 0 to 7) are ignored.

From one to eight cycles can be selected for the burst cycle, according to the settings of bits BSTS02 to BSTS00 and BSTS12 to BSTS10 in BROMCR. Wait cycles cannot be inserted. In addition, 4-word, 8-word, 16-word, or 32-word consecutive burst access can be performed according to the settings of BSTS01, BSTS00, BSTS11, and BSTS10 bits in BROMCR.

The basic access timing for burst ROM space is shown in figures 9.29 and 9.30.

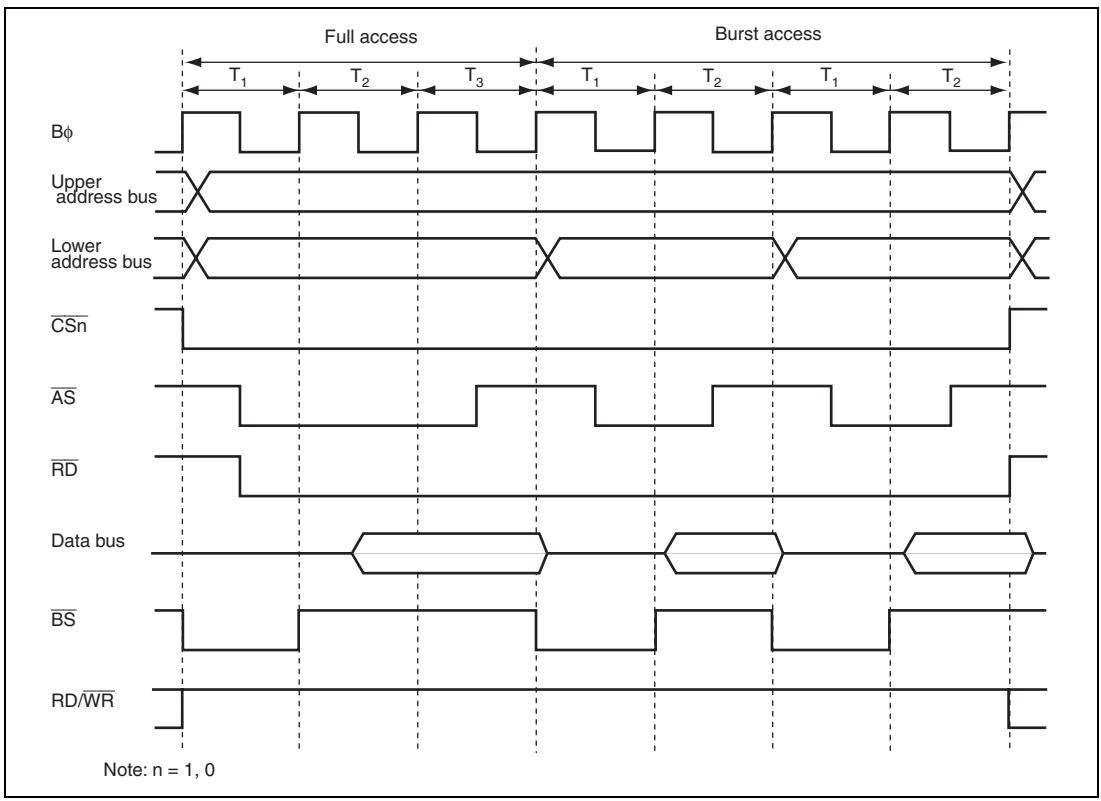

Figure 9.29 Example of Burst ROM Access Timing (ASTn = 1, Two Burst Cycles)

- DMDR_1 to DMDR_3

Bit	31	30	29	28	27	26	25	24
Bit Name	DTE	DACKE	TENDE	—	DREQS	NRD	—	—
Initial Value	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R	R
Bit	23	22	21	20	19	18	17	16
Bit Name	ACT	—	—	—	—	—	ESIF	DTIF
Initial Value	0	0	0	0	0	0	0	0
R/W	R	R	R	R	R	R	R/(W)*	R/(W)*
Bit	15	14	13	12	11	10	9	8
Bit Name	DTSZ1	DTSZ0	MDS1	MDS0	TSEIE	—	ESIE	DTIE
Initial Value	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R	R/W	R/W
Bit	7	6	5	4	3	2	1	0
Bit Name	DTF1	DTF0	DTA	—	—	DMAP2	DMAP1	DMAP0
Initial Value	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R	R	R/W	R/W	R/W

Note: * Only 0 can be written to this bit after having been read as 1, to clear the flag.

Figure 10.13 shows an example of timing in cycle stealing mode. The transfer conditions are as follows:

- Address mode: Single address mode
- Sampling method of the $\overline{\text{DREQ}}$ signal: Low level detection

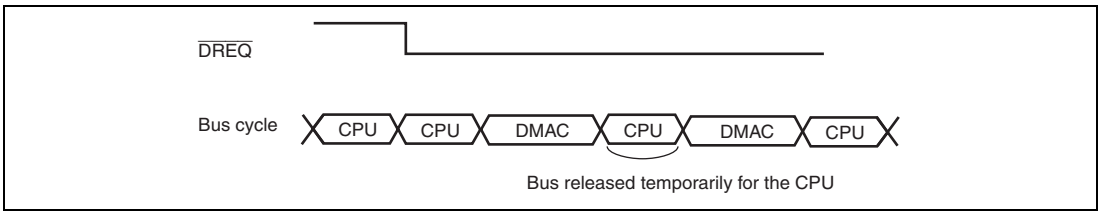

Figure 10.13 Example of Timing in Cycle Stealing Mode

(2) Burst Access Mode

In burst mode, once it takes the bus, the DMAC continues a transfer without releasing the bus until the transfer end condition is satisfied. Even if a transfer is requested from another channel having priority, the transfer is not stopped once it is started. The DMAC releases the bus in the next cycle after the transfer for the channel in burst mode is completed. This is similarly to operation in cycle stealing mode. However, setting the IBCCS bit in BCR2 of the bus controller makes the DMAC release the bus to pass the bus to another bus master.

In block transfer mode, the burst mode setting is ignored (operation is the same as that in burst mode during one block of transfers). The DMAC is always operated in cycle stealing mode.

Clearing the DTE bit in DMDR stops a DMA transfer. A transfer requested before the DTE bit is cleared to 0 by the DMAC is executed. When an interrupt by a transfer size error, a repeat size end, or an extended repeat area overflow occurs, the DTE bit is cleared to 0 and the transfer ends.

Figure 10.14 shows an example of timing in burst mode.

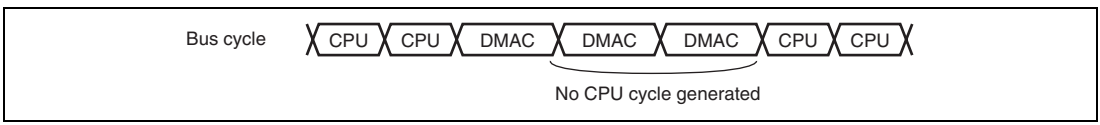

Figure 10.14 Example of Timing in Burst Mode

13.3.1 Port Function Control Register 0 (PFCR0)

PFCR0 enables/disables the $\overline{CS}$ output.

Bit	7	6	5	4	3	2	1	0
Bit Name	CS7E	CS6E	CS5E	CS4E	CS3E	CS2E	CS1E	CS0E
Initial Value	0	0	0	0	0	0	0	Undefined*
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: * 1 in external extended mode; 0 in other modes.

Bit	Bit Name	Initial Value	R/W	Description
7	CS7E	0	R/W	CS7 to CS0 Enable
6	CS6E	0	R/W	These bits enable/disable the corresponding $\overline{CSn}$ output.
5	CS5E	0	R/W	0: Pin functions as I/O port
4	CS4E	0	R/W	1: Pin functions as $\overline{CSn}$ output pin
3	CS3E	0	R/W	(n = 7 to 0)
2	CS2E	0	R/W	
1	CS1E	0	R/W	
0	CS0E	Undefined*	R/W	

Note: * 1 in external extended mode, 0 in other modes.

13.3.9 Port Function Control Register A (PFCRA)

PFCRA selects the multiple functions for the TPU I/O pins.

Bit	7	6	5	4	3	2	1	0
Bit Name	TPUMS11	TPUMS10	TPUMS9A	TPUMS9B	TPUMS8	TPUMS7	TPUMS6A	TPUM6B
Initial Value	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Bit	Bit Name	Initial Value	R/W	Description
7	TPUMS11	0	R/W	TPU I/O Pin Multiplex Function Select Selects TIOCA11 function. 0: Specifies pin PK6 as output compare output and input capture 1: Specifies PK7 as input capture input and PK6 as output compare
6	TPUMS10	0	R/W	TPU I/O Pin Multiplex Function Select Selects TIOCA10 function. 0: Specifies PK4 as output compare output and input capture 1: Specifies PK5 as input capture input and PK4 as output compare
5	TPUMS9A	0	R/W	TPU I/O Pin Multiplex Function Select Selects TIOCA9 function. 0: Specifies PK0 as output compare output and input capture 1: Specifies PK1 as input capture input and PK0 as output compare
4	TPUMS9B	0	R/W	TPU I/O Pin Multiplex Function Select Selects TIOCC9 function. 0: Specifies PK2 as output compare output and input capture 1: Specifies PK3 as input capture input and PK2 as output compare

(b) When TGR is an input capture register

Figure 14.17 shows an operation example in which TGRA has been designated as an input capture register, and buffer operation has been designated for TGRA and TGRC.

Counter clearing by TGRA input capture has been set for TCNT, and both rising and falling edges have been selected as the TIOCA pin input capture input edge.

As buffer operation has been set, when the TCNT value is stored in TGRA upon occurrence of input capture A, the value previously stored in TGRA is simultaneously transferred to TGRC.

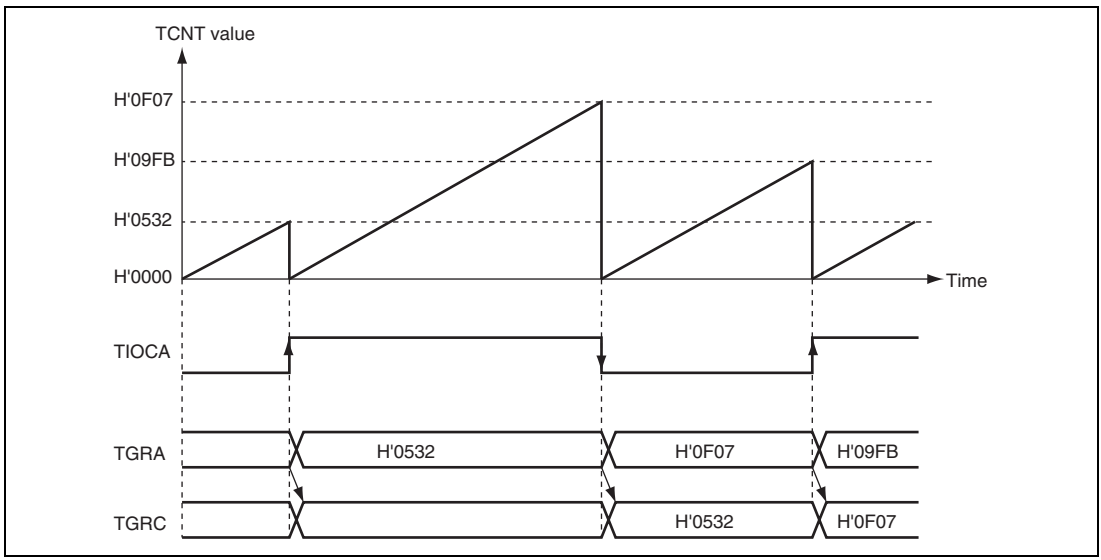

Figure 14.17 Example of Buffer Operation (2)

14.10 Usage Notes

14.10.1 Module Stop Function Setting

Operation of the TPU can be disabled or enabled using the module stop control register. The initial setting is for operation of the TPU to be halted. Register access is enabled by clearing module stop state. For details, see section 28, Power-Down Modes.

14.10.2 Input Clock Restrictions

The input clock pulse width must be at least 1.5 states in the case of single-edge detection, and at least 2.5 states in the case of both-edge detection. The TPU will not operate properly with a narrower pulse width.

In phase counting mode, the phase difference and overlap between the two input clocks must be at least 1.5 states, and the pulse width must be at least 2.5 states. Figure 14.46 shows the input clock conditions in phase counting mode.

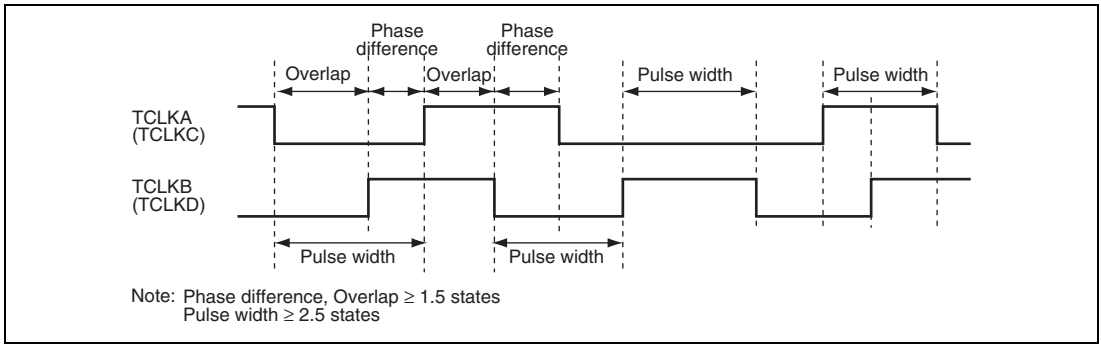

Figure 14.46 Phase Difference, Overlap, and Pulse Width in Phase Counting Mode

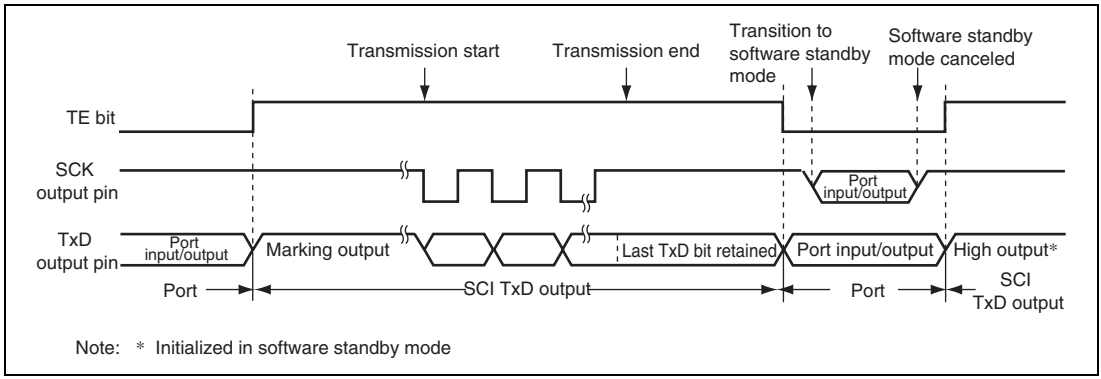

Figure 19.41 Port Pin States during Software Standby Mode Transition (Internal Clock, Clocked Synchronous Transmission) (Setting is Prohibited in SCI_5 and SCI_6)

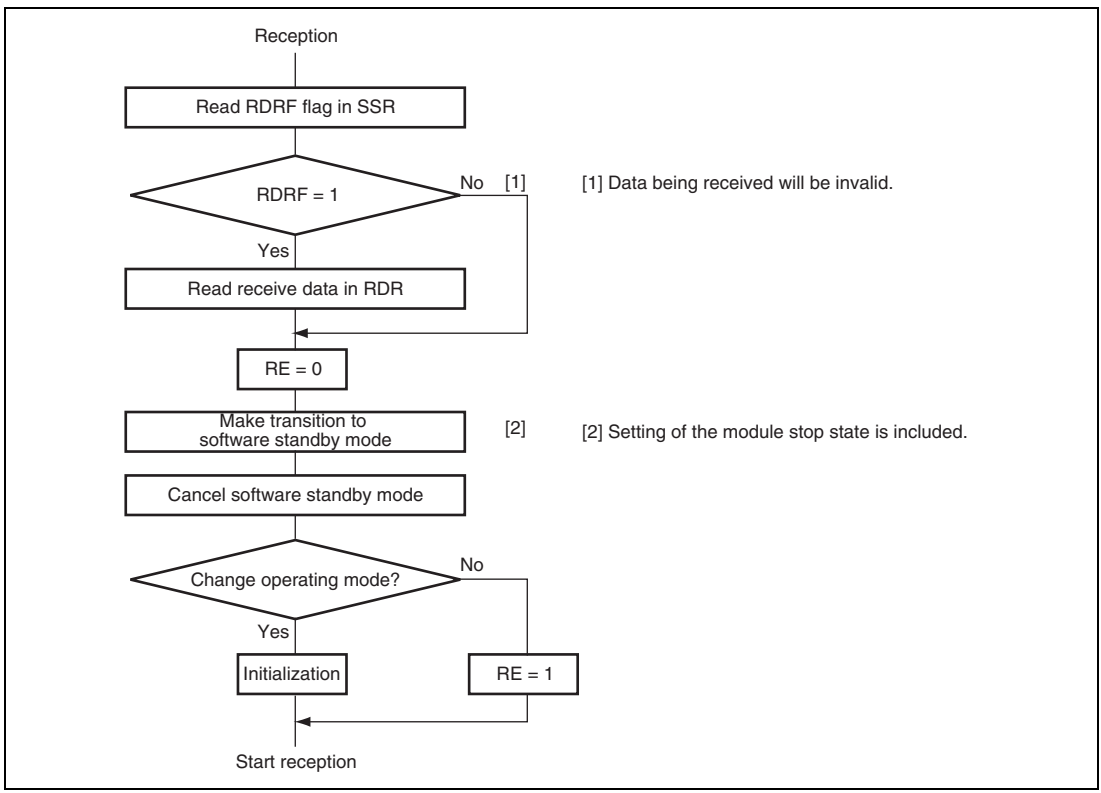

Figure 19.42 Sample Flowchart for Software Standby Mode Transition during Reception

20.3.8 Interrupt Enable Register 1 (IER1)

IER1 enables the interrupt requests of interrupt flag register 1 (IFR1). When an interrupt flag is set to 1 while the corresponding bit of each interrupt is set to 1, an interrupt request is sent to the CPU. The interrupt vector number is determined by the contents of interrupt select register 1 (ISR1).

Bit	7	6	5	4	3	2	1	0
Bit Name	—	—	—	—	—	EP3 TR	EP3 TS	VBUSF
Initial Value	0	0	0	0	0	0	0	0
R/W	R	R	R	R	R	R/W	R/W	R/W

Bit	Bit Name	Initial Value	R/W	Description
7	—	0	R	Reserved
6	—	0	R	These bits are always read as 0. The write value should always be 0.
5	—	0	R	
4	—	0	R	
3	—	0	R	
2	EP3 TR	0	R/W	EP3 Transfer Request
1	EP3 TS	0	R/W	EP3 Transmission Complete
0	VBUSF	0	R/W	USB Bus Connect

20.3.9 Interrupt Enable Register 2 (IER2)

IER2 enables the interrupt requests of interrupt flag register 2 (IFR2). When an interrupt flag is set to 1 while the corresponding bit of each interrupt is set to 1, an interrupt request is sent to the CPU. The interrupt vector number is determined by the contents of interrupt select register 2 (ISR2).

Bit	7	6	5	4	3	2	1	0
Bit Name	SSRSME	—	—	SURSE	CFDN	—	SETCE	SETIE
Initial Value	0	0	0	0	0	0	0	0
R/W	R/W	R	R	R/W	R/W	R	R/W	R/W

(f) Operating Clock Frequency Inquiry

The boot program will return the number of operating clock frequencies, and the maximum and minimum values.

Command

H'23

- Command, H'23, (one byte): Inquiry regarding operating clock frequencies

Response

H'33	Size	Number of operating clock frequencies
Minimum value of operating clock frequency		Maximum value of operating clock frequency
...		
SUM		

- Response, H'33, (one byte): Response to operating clock frequency inquiry
- Size (one byte): The number of bytes that represents the minimum values, maximum values, and the number of frequencies.
- Number of operating clock frequencies (one byte): The number of supported operating clock frequency types
  (e.g. when there are two operating clock frequency types, which are the main and peripheral clocks, the number of types will be H'02.)
- Minimum value of operating clock frequency (two bytes): The minimum value of the multiplied or divided clock frequency.

  The minimum and maximum values of the operating clock frequency represent the values in MHz, valid to the hundredths place of MHz, and multiplied by 100. (e.g. when the value is 17.00 MHz, it will be 2000, which is H'07D0.)
- Maximum value (two bytes): Maximum value among the multiplied or divided clock frequencies.

  There are as many pairs of minimum and maximum values as there are operating clock frequencies.
- SUM (one byte): Checksum

Clock oscillation and internal power supply start as soon as the signal on the $\overline{\text{RES}}$ pin is driven low. At the same time, clock signals are supplied to the LSI. In this case, the $\overline{\text{RES}}$ pin has to be held low until the clock oscillation has become stable. Once the signal on the $\overline{\text{RES}}$ pin is driven high, the CPU starts reset exception handling.

5. Exit from deep software standby mode by the signal on the $\overline{\text{STBY}}$ pin

   When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode.

Note: * Supported only by the H8SX/1668M Group.

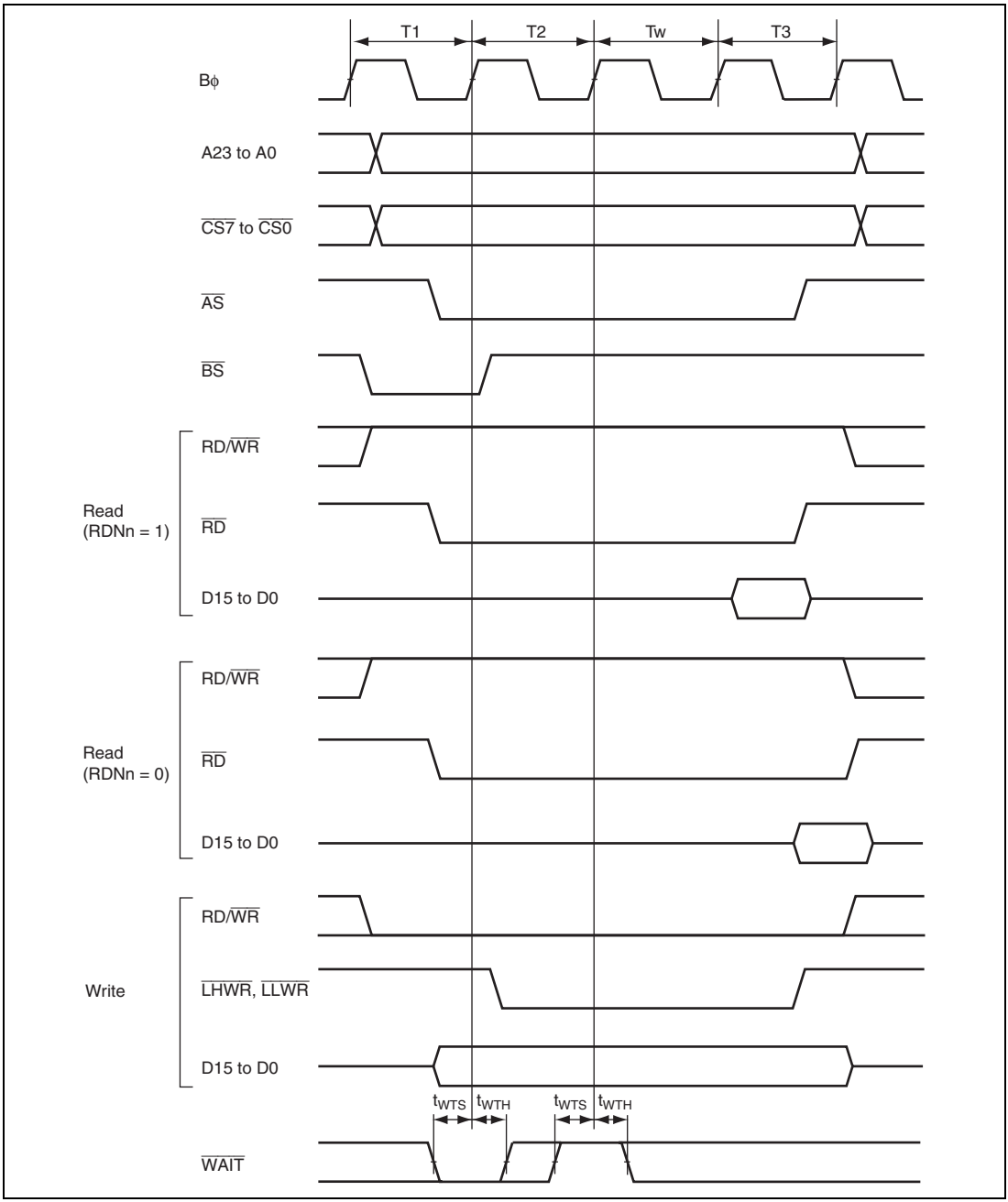

Figure 30.10 Basic Bus Timing: Three-State Access, One Wait